



H4
NY PMS 440 0025 PH

H5
NY PMS 440 0025 PH

H6
NY PMS 440 0025 PH

H7
NY PMS 440 0025 PH

H8
1902C

H9
1902C

H10
1902C

H11
1902C

PCB Number: TIDA-00367
PCB Rev: E2

PCB
LOGO
Texas Instruments

PCB
LOGO
Pb-Free Symbol

Label Table

| Variant | Label Text |
|---------|------------|
| 001 | ChangeMe! |
| 002 | ChangeMe! |
| | |
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| | |
| | |
| | |

ZZ1
Assembly Note

These assemblies are ESD sensitive, ESD precautions shall be observed.

ZZ2
Assembly Note

These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.

ZZ3
Assembly Note

These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.

Orderable: N/A

TID #: TIDA-00367

Number: TIDA-00367

Rev: E2

Drawn By: Ramkumar S

Engineer: Ramkumar S

Designed for: Public Release

Project Title: 150W POWER SUPPLY

Sheet Title: Assembly Variant:001

File: TID_Hardware_SchDoc

Contact: http://www.ti.com/support

Mod. Date: 10/8/2015

Sheet: 2 of 2

Size: B

TEXAS
INSTRUMENTS

http://www.ti.com

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